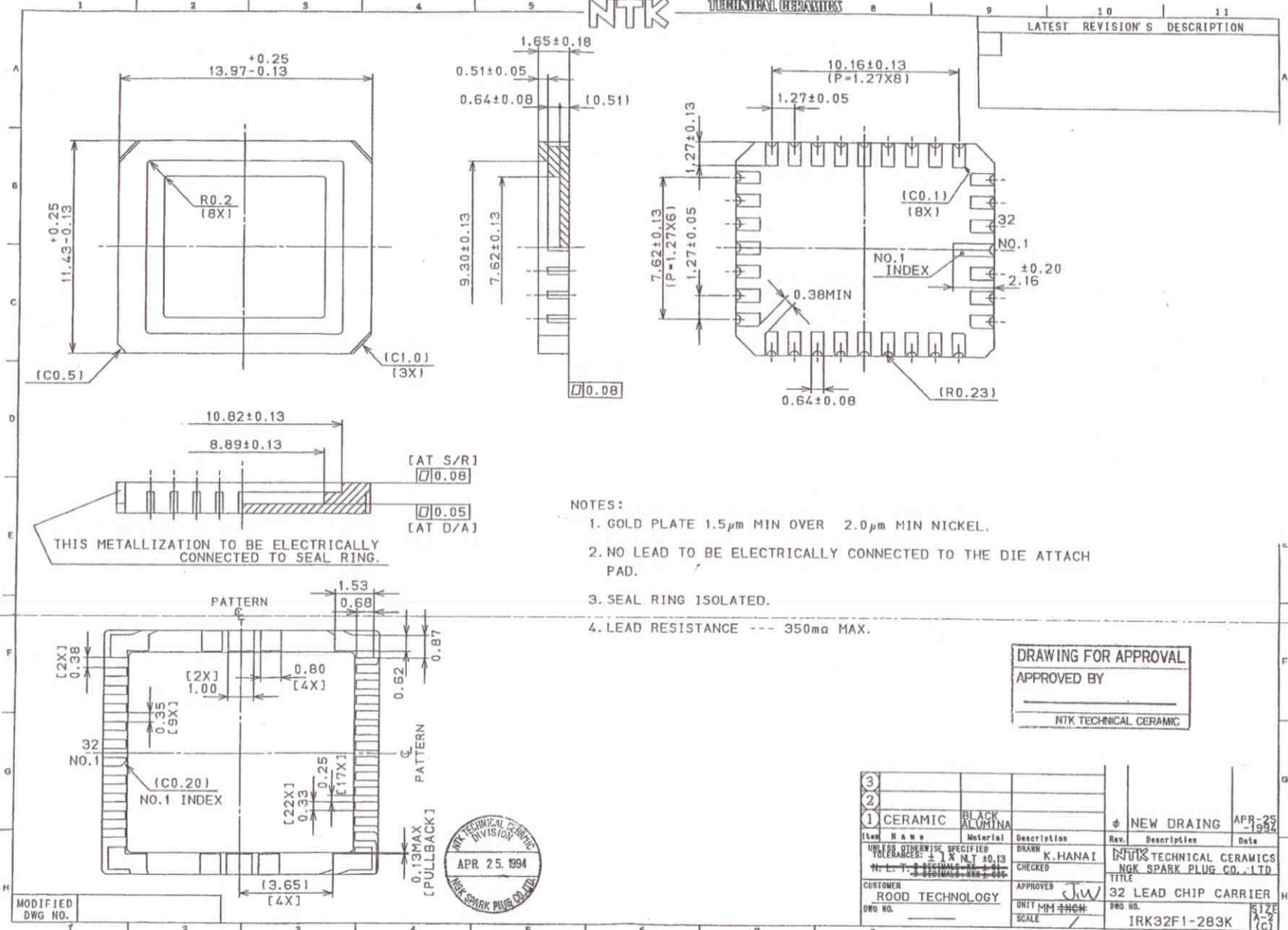


NTK

TERMINAL CERAMICS

LATEST REVISIONS DESCRIPTION



- NOTES:
1. GOLD PLATE 1.5µm MIN OVER 2.0µm MIN NICKEL.
 2. NO LEAD TO BE ELECTRICALLY CONNECTED TO THE DIE ATTACH PAD.
 3. SEAL RING ISOLATED.
 4. LEAD RESISTANCE --- 350mΩ MAX.

DRAWING FOR APPROVAL
 APPROVED BY
 NTK TECHNICAL CERAMIC

NTK TECHNICAL CERAMIC DIVISION
 APR 25 1994
 NGK SPARK PLUG CO. LTD.

3							
2							
1	CERAMIC	BLACK ALUMINA		NEW DRAING	APR-25-1994		
Item Name	Material	Description	Rev.	Description	Date		
UNLESS OTHERWISE SPECIFIED TOLERANCES: ± 1% N.T ± 0.13		DRAWN	K.HANAI	NTK TECHNICAL CERAMICS			
N.T. T. 3 DECIMALS 10 1 01		CHECKED		NGK SPARK PLUG CO., LTD			
3 DECIMALS 10 1 01		APPROVED	CHW	TITLE			
CUSTOMER		UNIT	MM	32 LEAD CHIP CARRIER			
ROOD TECHNOLOGY		SCALE	ENG	IRK32F1-2B3K			
DWG NO.				PRO NO.			
				SCALE			

PART NO. SHEET 1 OF 1 M·H

